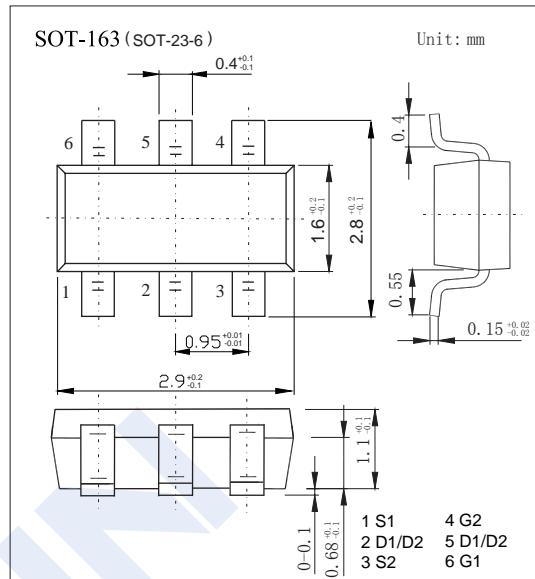
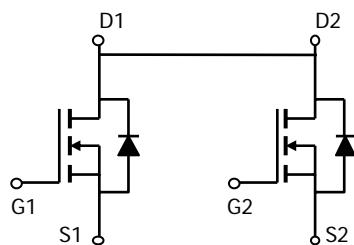


## Dual N-Channel MOSFET

### AO6804 (KO6804)

#### ■ Features

- $V_{DS} (V) = 20V$
- $I_D = 5 A (V_{GS} = 4.5V)$
- $R_{DS(ON)} < 32m\Omega (V_{GS} = 4.5V)$
- $R_{DS(ON)} < 34m\Omega (V_{GS} = 4V)$
- $R_{DS(ON)} < 37m\Omega (V_{GS} = 3.1V)$
- $R_{DS(ON)} < 42m\Omega (V_{GS} = 2.5V)$



#### ■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter		Symbol	10 Sec	Steady State	Unit
Drain-Source Voltage		$V_{DS}$	20		V
Continuous Drain Current	TA=25°C	$I_D$	5	4	A
	TA=70°C		4	3.2	
Pulsed Drain Current		$I_{DM}$	25		W
Power Dissipation	TA=25°C	$P_D$	1.3	0.8	
	TA=70°C		0.8	0.5	
Thermal Resistance.Junction- to-Ambient		$R_{thJA}$	95	150	°C/W
Thermal Resistance.Junction- to-Lead		$R_{thJL}$	-	68	
Junction Temperature		$T_J$	150		°C
Storage Temperature Range		$T_{stg}$	-55 to 150		

## Dual N-Channel MOSFET

### AO6804 (KO6804)

■ Electrical Characteristics  $T_a = 25^\circ\text{C}$

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{DSS}$	$I_D=250 \mu\text{A}, V_{GS}=0\text{V}$	20			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=20\text{V}, V_{GS}=0\text{V}$			1	uA
		$V_{DS}=20\text{V}, V_{GS}=0\text{V}, T_J=55^\circ\text{C}$			5	
Gate-Body Leakage Current	$I_{GSS}$	$V_{DS}=0\text{V}, V_{GS}=\pm 12\text{V}$			$\pm 500$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250 \mu\text{A}$	0.5		1.2	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=4.5\text{V}, I_D=5\text{A}$			32	mΩ
		$V_{GS}=4.5\text{V}, I_D=5\text{A} T_J=125^\circ\text{C}$			43	
		$V_{GS}=4\text{V}, I_D=4.5\text{A}$			34	
		$V_{GS}=3.1\text{V}, I_D=4.5\text{A}$			37	
		$V_{GS}=2.5\text{V}, I_D=4\text{A}$			42	
On State Drain Current	$I_D(\text{ON})$	$V_{GS}=4.5\text{V}, V_{DS}=5\text{V}$	25			A
Forward Transconductance	$g_{FS}$	$V_{DS}=5\text{V}, I_D=5\text{A}$		7		S
Input Capacitance	$C_{iss}$	$V_{GS}=0\text{V}, V_{DS}=10\text{V}, f=1\text{MHz}$		580	725	pF
Output Capacitance	$C_{oss}$			95		
Reverse Transfer Capacitance	$C_{rss}$			70		
Gate Resistance	$R_g$	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		3.5	5.3	Ω
Total Gate Charge	$Q_g$	$V_{GS}=4.5\text{V}, V_{DS}=10\text{V}, I_D=5\text{A}$		5.8	7.7	nC
Gate Source Charge	$Q_{gs}$			1		
Gate Drain Charge	$Q_{gd}$			1.6		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS}=10\text{V}, V_{DS}=10\text{V}, R_L=2\Omega, R_G=3\Omega$		2.4		ns
Turn-On Rise Time	$t_r$			6.4		
Turn-Off Delay Time	$t_{d(off)}$			38		
Turn-Off Fall Time	$t_f$			9.5		
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F=5\text{A}, dI/dt=100\text{A/us}$		18	24	nC
Body Diode Reverse Recovery Charge	$Q_{rr}$			6		
Maximum Body-Diode Continuous Current	$I_S$				1.1	A
Diode Forward Voltage	$V_{SD}$	$I_S=1\text{A}, V_{GS}=0\text{V}$			1	V

\* The static characteristics in Figures 1 to 6 are obtained using <300us pulses, duty cycle 0.5% max.

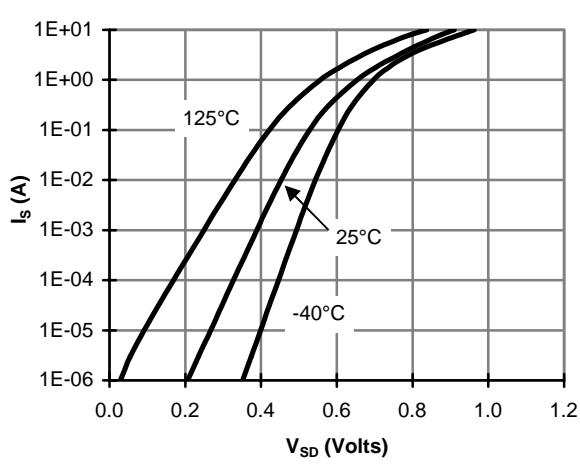
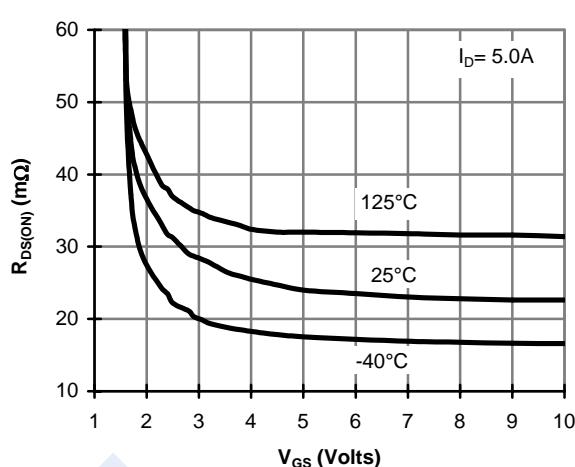
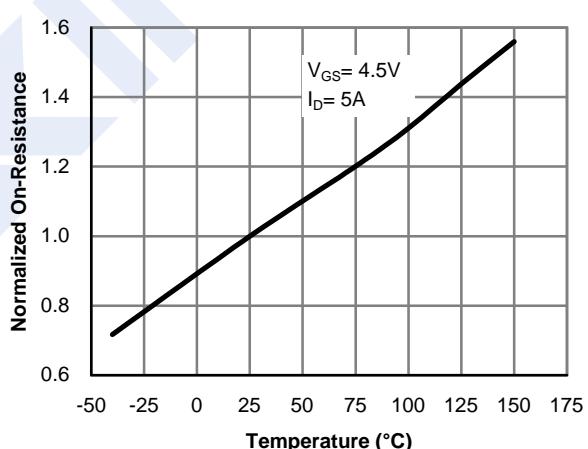
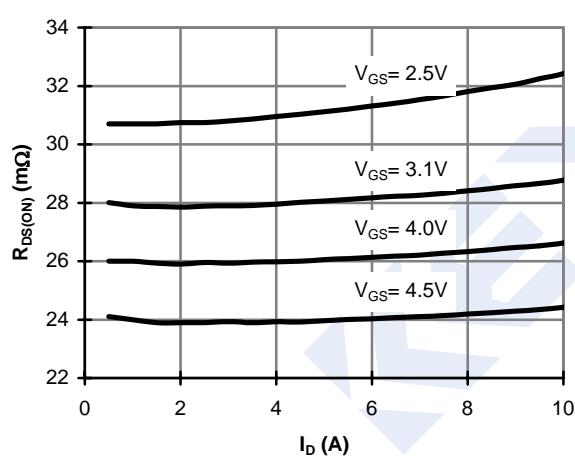
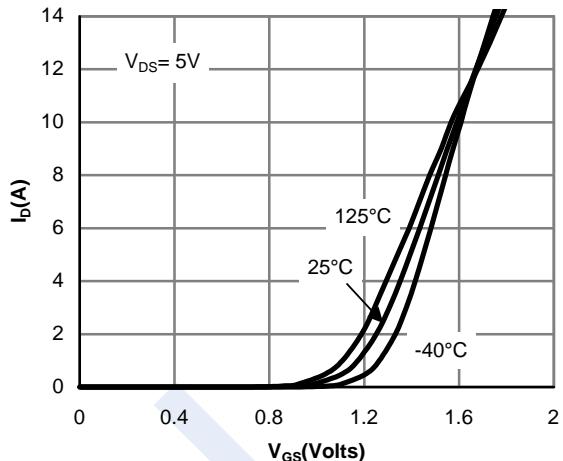
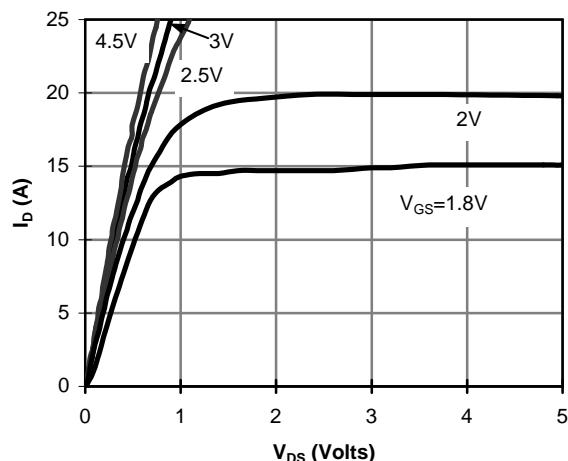
#### ■ Marking

Marking	H4**
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## Dual N-Channel MOSFET

### AO6804 (KO6804)

■ Typical Characteristics



## Dual N-Channel MOSFET

### AO6804 (KO6804)

■ Typical Characteristics

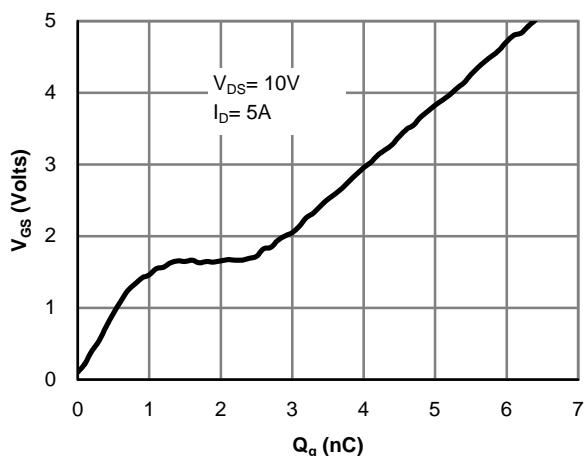


Figure 7: Gate-Charge Characteristics

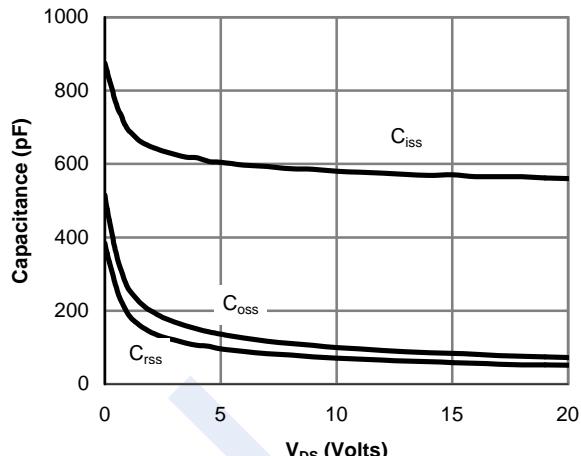


Figure 8: Capacitance Characteristics

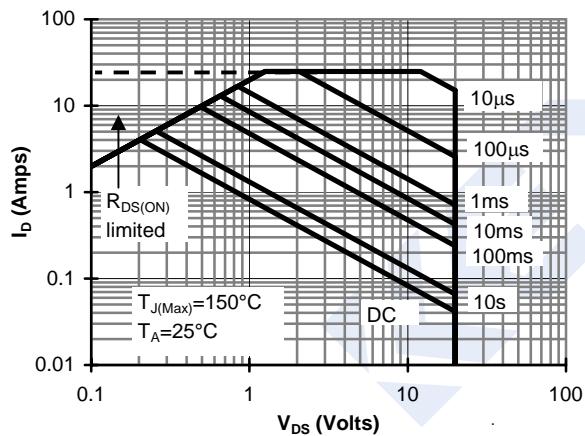


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

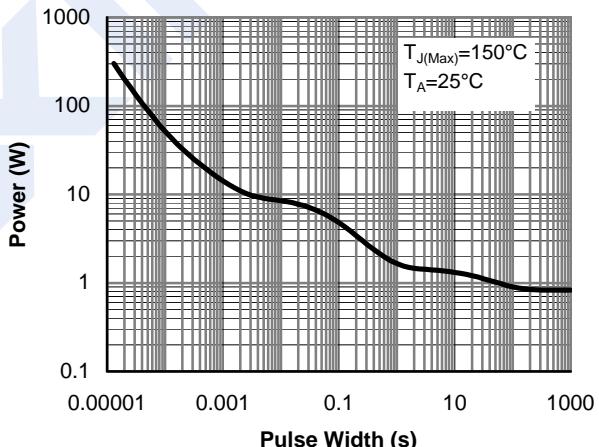


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

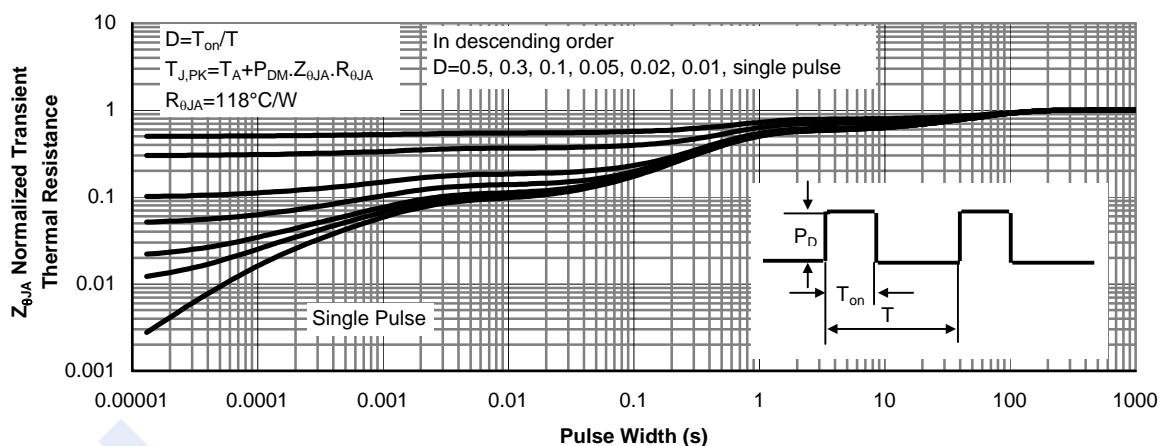


Figure 11: Normalized Maximum Transient Thermal Impedance (Note E)